



50V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(ON)} max	I _D max T _A = +25°C
50V	$15m\Omega @ V_{GS} = 10V$	9.1A
307	$23m\Omega @ V_{GS} = 4.5V$	7.4A

Description and Applications

This MOSFET is designed to minimize the on-state resistance $(R_{DS(ON)})$ and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Load Switch
- Adaptor Switch
- Notebook PC

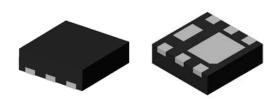
Features

- 0.6mm Profile Ideal for Low Profile Applications
- PCB Footprint of 4mm²
- Low Gate Threshold Voltage
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

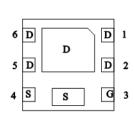
- Case: U-DFN2020-6
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (4)
- Weight: 0.007 grams (Approximate)

U-DFN2020-6

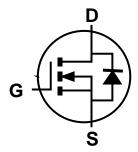


Top View

Bottom View



Pin Out Bottom View



Internal Schematic

Ordering Information (Note 4)

Part Number	Marking	Reel size (inches)	Quantity per reel
DMT5015LFDF-7	T5	7	3,000
DMT5015LFDF-13	T5	13	10,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



T5 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: A = 2014) M = Month (ex: 9 = September)

Date Code Key

Year	201	4	2015		2016	20	17	2018		2019	2	2020	
Code	В		С		D		D E		F		G		Н
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec	
Code	1	2	3	4	5	6	7	8	9	0	N	D	



Characteristic	Symbol	Value	Units		
Drain-Source Voltage	V_{DSS}	50	V		
Gate-Source Voltage	V _{GSS}	±16	V		
Continuous Dunis Comment (Nata C) V	T _A = +25°C T _A = +70°C	I _D	9.1 7.3	А	
Continuous Drain Current (Note 6) V _{GS} = 10V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	11.5 9.2	А
Pulsed Drain Current (10µs pulse, duty cycle = 1%)		I _{DM}	60	А	
Continuous Source-Drain Diode Current	Is	2.2	Α		
Avalanche Current (Note 7) L = 0.1mH	I _{AS}	14.4	А		
Avalanche Energy (Note 7) L = 0.1mH	E _{AS}	10.4	mJ		

Thermal Characteristics

Characteristic	Symbol	Value	Units		
Total Dower Discipation (Note 5)	T _A = +25°C	D	0.82	W	
Total Power Dissipation (Note 5)	T _A = +70°C	P_{D}	0.52		
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	-	153	°C/W	
mermai Resistance, Junction to Ambient (Note 5)	t<10s	$R_{\theta JA}$	96		
Total Power Dissipation (Note 6)	T _A = +25°C	р	1.97	W	
Total Power Dissipation (Note 6)	$T_A = +70^{\circ}C$	P_{D}	1.2	VV	
Thermal Resistance, Junction to Ambient (Note 6)	Steady state	Ъ	67	°C/W	
mermai Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	42		
Thermal Resistance, Junction to Case (Note 6)	Steady state	$R_{\theta JC}$	14		
Operating and Storage Temperature Range		$T_{J_1}T_{STG}$	-55 to +150	°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)			71		I.	-	
Drain-Source Breakdown Voltage	BV _{DSS}	50	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	_	_	1	μΑ	V _{DS} = 40V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 16V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	$V_{GS(th)}$	0.5	_	2.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance			_	15		$V_{GS} = 10V, I_D = 8A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	_	23	mΩ	$V_{GS} = 4.5V, I_D = 6A$	
Diode Forward Voltage	V_{SD}	_	0.7	1.0	V	$V_{GS} = 0V, I_{S} = 5A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C _{iss}	_	902.7	l		V 05V V 0V	
Output Capacitance	Coss	_	301.4		pF	$V_{DS} = 25V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	15.2	_		I = I.UIVIMZ	
Gate Resistance	R_g	_	1.9	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	6.1	_			
Total Gate Charge (V _{GS} = 10V)	Q_g	_	14	_), OF), I OA	
Gate-Source Charge	Q _{gs}	_	2.4	_	nC	$V_{DS} = 25V, I_{D} = 8A$	
Gate-Drain Charge	Q_{gd}	_	1.6	_			
Turn-On Delay Time	t _{D(on)}	_	2.8	_			
Turn-On Rise Time	t _r	_	5.1	_		$V_{DS} = 25V, V_{GS} = 10V,$	
Turn-Off Delay Time	t _{D(off)}	_	10.6	_	ns	$R_G = 3\Omega$, $I_D = 8A$	
Turn-Off Fall Time	t _f	_	2.7				
Reverse Recovery Time	t _{rr}	_	18.9		ns	I _F = 8A, di/dt = 100A/μs	
Reverse Recovery Charge	Q _{rr}		9.2	1	nC	I _F = 8A, di/dt = 100A/μs	

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

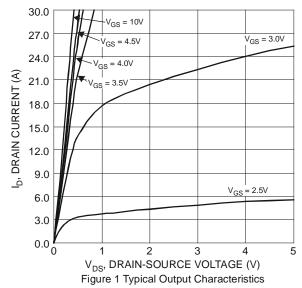
^{6.} Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

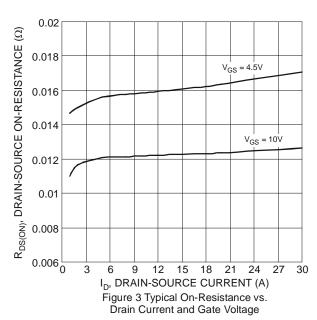
^{7.} I_{AS} and E_{AS} rating are based on low frequency and duty cycles to keep $T_{J} = +25$ °C.

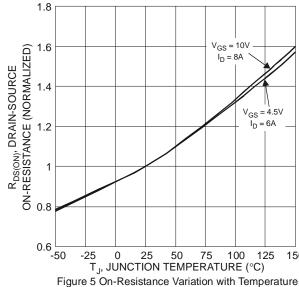
Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.

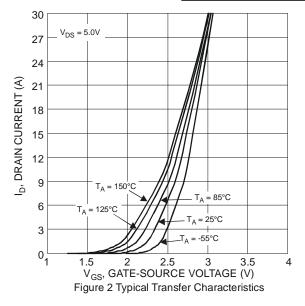
DMT5015LFDF

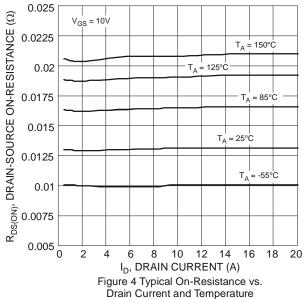












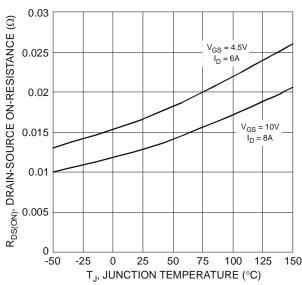


Figure 6 On-Resistance Variation with Temperature

DMT5015LFDF



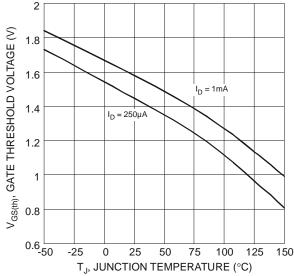


Figure 7 Gate Threshold Variation vs. Ambient Temperature

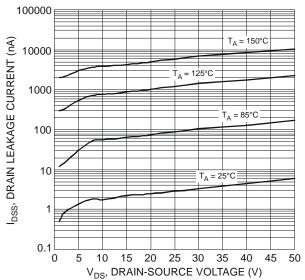
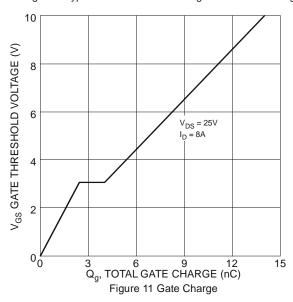
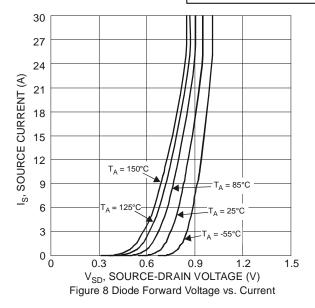
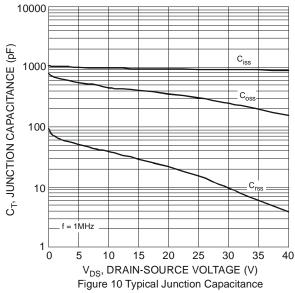
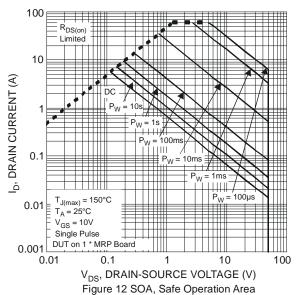


Figure 9 Typical Drain-Source Leakage Current vs. Voltage

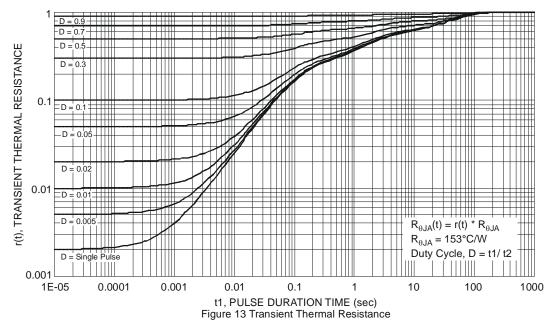






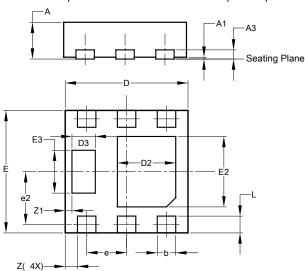






Package Outline Dimensions

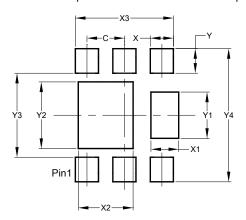
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



U-DFN2020-6							
(Type F)							
Dim	Min	Min Max Typ					
Α	0.57	0.63	0.60				
A1	0	0.05	0.03				
A3	-	-	0.15				
b	0.25	0.35	0.30				
D	1.95	2.05	2.00				
D2	0.85	0.85 1.05 0.95					
D3	0.33 0.43 0.38						
е	0.65 BSC						
e2	().863 B	SC				
Е	1.95	2.05	2.00				
E2	1.05	1.25	1.15				
E3	0.65	0.75	0.70				
L	0.225 0.325 0.275						
Z	0.20 BSC						
Z1	0.110 BSC						
All	Dimen	sions	in mm				

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



U-DFN2020-6 (Type F)

Dimensions	Value (in mm)
С	0.650
X	0.400
X1	0.480
X2	0.950
Х3	1.700
Y	0.425
Y1	0.800
Y2	1.150
Y3	1.450
Y4	2.300



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